

ISFSE 2017 3rd International Symposium of Flexible and Stretchable Electronics

29-30 June 2017, Wuhan, China

Welcome Message

On behalf of the organizing committee, we would like to invite you to International Symposium of Flexible and Stretchable Electronics, which will take place in Wuhan, China on June 29-30, 2017.

Driven by emerged new materials and technology, flexible and stretchable electronics is a rapidly growing field, providing unprecedented features for next generation electronics. ISFSE 2017 creates an exclusive exchange platform addressing innovative technology of the future across a wide range of industry community, and it offers a unique opportunity to gather the researchers from all fields together to exchange the information, forge the ideas, and initiate collaboration. Quite a few scholars have been confirmed to join us.

The major areas of activity in the flexible and stretchable electronics solicited and expected at this symposium include but are not limited to:

- **Soft and bio-inspired materials:** New properties and functions enabled by deformation or soft materials
- **2D materials and devices:** Synthesis and electronic and optoelectronic applications
- **Mechanical design:** Mechanics and reliability
- **Advanced manufacturing:** Advanced Printing, IC packaging, Transfer Printing
- **Applications:** Wearable electronics, Health care, Compliant energy sources, Flexible display, Smart skin, Soft robotics
- **Instrumentation**

Presentation and Recommendation

High quality papers from this symposium will be selected to be published in a special issue of MDPI

Micromachines Journal

Organizing Committee General Chairs



Zhonglin Wang, GeorgiaTech., USA



Youlun Xiong, HUST, China

Program Chairs

Jianfeng Zang

Dehui Li

Chengliang Wang

Zhigang Wu

Rong Chen

Important Dates

Abstract Submission Deadline:

April 15, 2017

Acceptance Notification Deadline:

May 10, 2017

Conference date:

June 29-30, 2017

Contact Us

Website: www.isfse.org

E-mail: dmet@hust.edu.cn

Invited Scholars



Prof. Zhonglin Wang
GeorgiaTech., USA



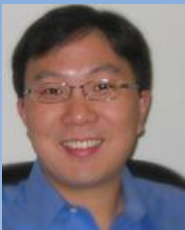
Prof. Xuanhe Zhao
MIT, USA



Prof. Zhoupin Yin
HUST, China



Prof. Dae-Hyeong Kim
Seoul National University, Korea



Prof. Xiangfeng Duan
UCLA, USA



Prof. Klas Hjort
LTH Lund University, Sweden



Prof. Hua Zhang
NTU, Singapore



Prof. Haixia Zhang
PKU, China



Prof. Jianbin Xu
CUHK, China



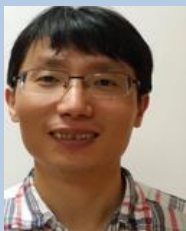
Prof. Qiaoliang Bao
Monash University, Australia



Prof. Yong Zhu
NCSU, USA



Prof. Qiming Wang
USC, USA



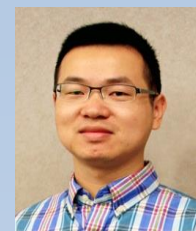
Prof. Guichuan Xing
Nanjing Tech, China



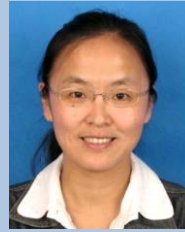
Prof. Juqing Liu
Nanjing Tech, China



Prof. Qihua Xiong
NTU, Singapore



Prof. Zheng Liu
NTU, Singapore



Prof. Zunfeng Liu
Nankai University, China

Prof. Jeong-Yun Sun
Seoul National University, Korea

Prof. Rong Sun
SIAT CAS, China

>> to be updated

